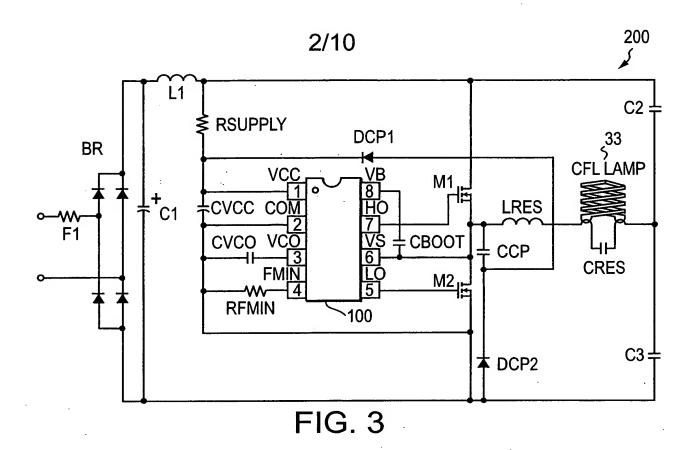


PIN ASSIGNMENTS	PIN#	SYMBOL	DESCRIPTION
100 - ر	1	VCC	SUPPLY VOLTAGE
VCC 1 8 VB	2	COM	IC POWER & SIGNAL GROUND
	3	VCO	VOLTAGE CONTROLLED OSCILLATOR INPUT
COM 2 7 HO	4	FMIN	MINIMUM FREQUENCY SETTING
vco3 6vs	5	LO	LOW-SIDE GATE DRIVER OUTPUT
	6	VS	HIGH-SIDE FLOATING RETURN
FMIN 4 5 LO	7	НО	HIGH-SIDE GATE DRIVER OUTPUT
	8	VB	HIGH-SIDE GATE DRIVER FLOATING SUPPLY

FIG. 2



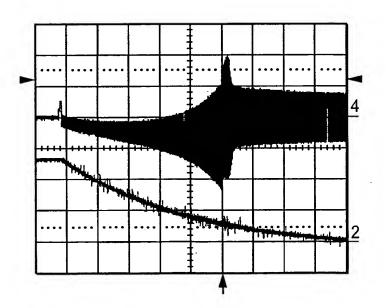


FIG. 4

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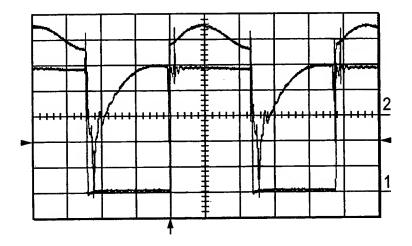


FIG. 5

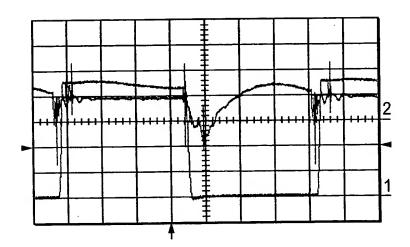
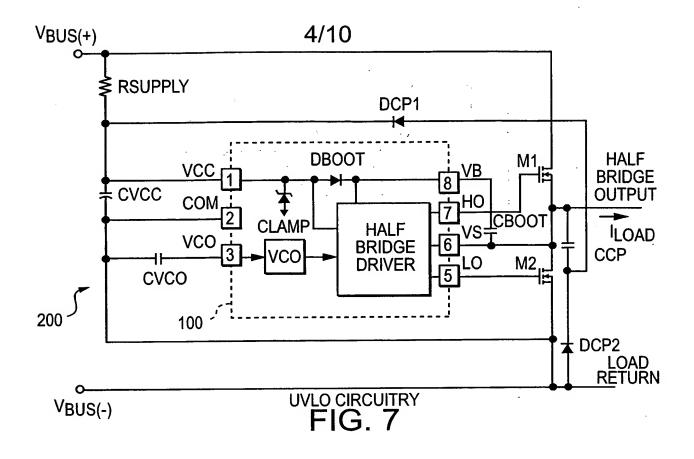
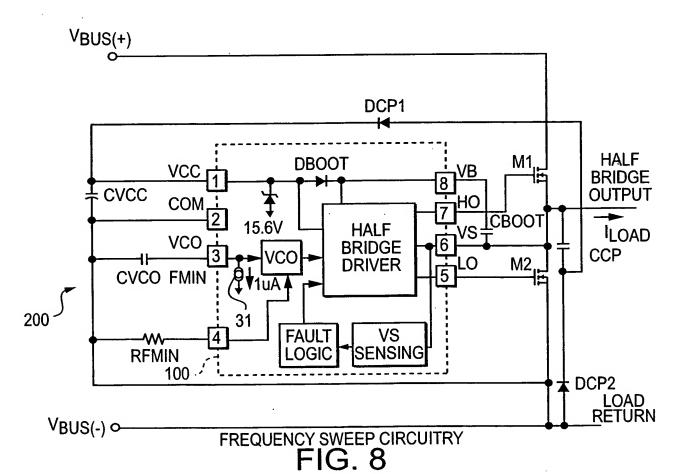
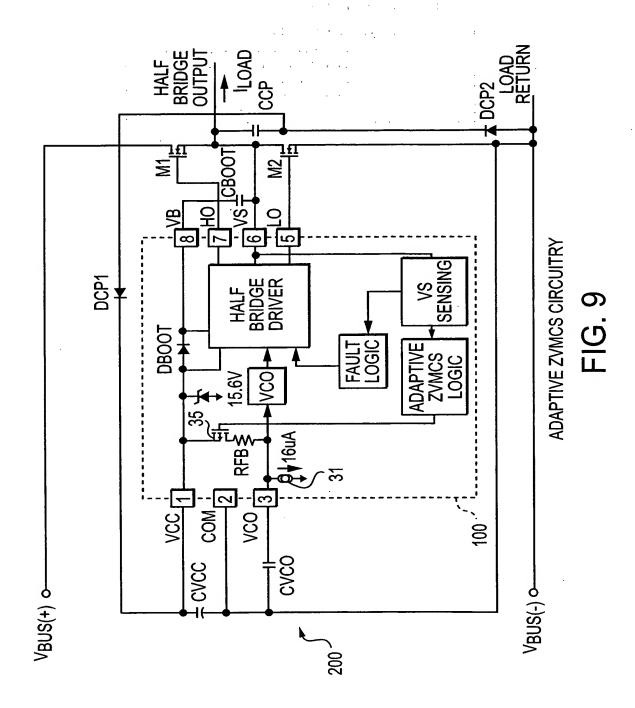


FIG. 6







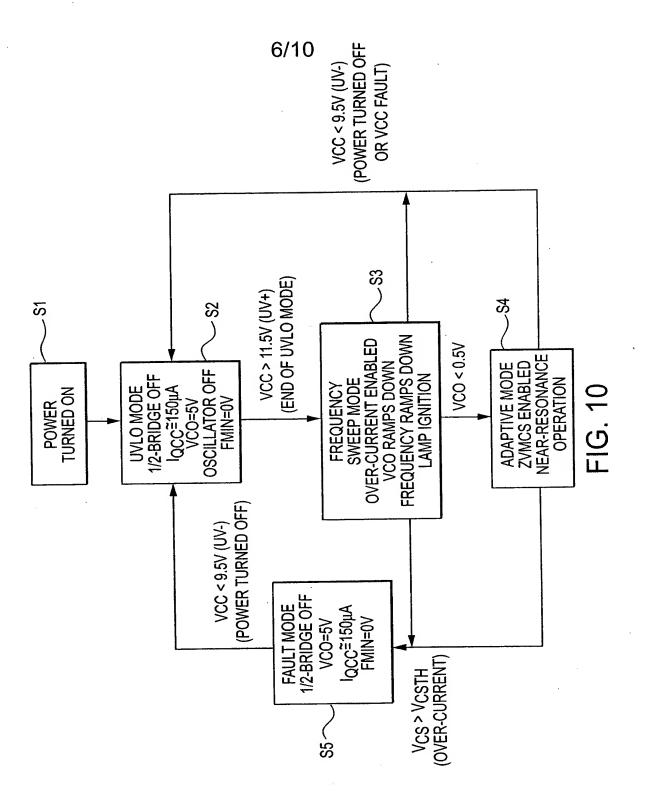


TABLE 1

RECOMMENDED OPERATING CONDITIONS FOR PROPER OPERATION THE RECOMMENDED CONDITIONS.

SYMBOL	DEFINITION	MIN	MAX	UNITS
VBS	HIGH-SIDE FLOATING SUPPLY VOLTAGE	VCC - 0.7 VCLAMP	VCLAMP	
\S	STEADY STATE HIGH-SIDE FLOATING SUPPLY OFFSET VOLTAGE	-1	600	>
کر م	SUPPLY VOLTAGE	Vccuv+	VCLAMP	
<u>8</u>	SUPPLY CURRENT	NOTE 2	10	mA
RFMIN	MINIMUM FREQUENCY SETTING RESISTANCE	10	100	kΩ
VVCO	VCO PIN VOLTAGE	0	5	>.
L	JUNCTION TEMPERATURE	-25	125	၃

NOTE 2: ENOUGH CURRENT SHOULD BE SUPPLIED INTO THE VCC PIN TO KEEP THE INTERNAL 15.6V ZENER CLAMP DIODE ON THIS PIN REGULATING ITS VOLTAGE, V_{CLAMP}.

TABLE 2

ALL VOLTAGE PARAMETERS ARE ABSOLUTE VOLTAGES REFERENCED TO COM, ALL CURRENTS ARE DEFINED POSITIVE INTO ANY LEAD. THE THERMAL RESISTANCE AND POWER DISSIPATION RATINGS ARE MEASURED UNDER BOARD ABSOLUTE MAXIMUM RATINGS ABSOLUTE MAXIMUM RATINGS INDICATE SUSTAINED LIMITS BEYOND WHICH DAMAGE TO THE DEVICE MAY OCCUR. MOUNTED AND STILL AIR CONDITIONS.

SYMBOL	SYMBOL DEFINITION	MIN	MAX	UNITS
VB	HIGH-SIDE FLOATING SUPPLY VOLTAGE	-0.3	625	
VS	HIGH-SIDE FLOATING SUPPLY OFFSET VOLTAGE	VB - 25	VB + 0.3	, >
VHÖ	HIGH-SIDE FLOATING OUTPUT VOLTAGE	Vs-0.3	VB + 0.3	>
VLO	LOW-SIDE OUTPUT VOLTAGE	-0.3	Vcc + 0.3	,
lomax	MAXIMUM ALLOWABLE OUTPUT CURRENT (HO, LO) DUE TO EXTERNAL POWER TRANSISTOR MILLER EFFECT	009-	200	mA
VVCO	VOLTAGE CONTROLLED OSCILLATOR INPUT VOLTAGE	-0.3	VCC + 0.3	Λ
<u>33</u>	SUPPLY CURRENT (NOTE 1)	-20	20	mA
dV/dt	ALLOWABLE OFFSET VOLTAGE SLEW RATE	09-	50	V/ns.
PD	PACKAGE POWER DISSIPATION @ TA ≤ +25°C (8-PIN DIP)		-	. M
	$PD = (TJMAX-TA)/R_{\theta JA} $ (8-PIN SOIC)		0.625	A
КөЈА	THERMAL RESISTANCE, JUNCTION TO AMBIENT (8-PIN DIP)		125	WVJo
	(8-PIN SOIC)	••	200	
Ţ	JUNCTION TEMPERATURE	-55	150	
TS	STORAGE TEMPERATURE	-55	150	ပွ
۔	LEAD TEMPERATURE (SOLDERING, 10 SECONDS)	1	300	

NOTE 1: THIS IC CONTAINS A ZENER CLAMP STRUCTURE BETWEEN THE CHIP VCC AND COM, WHICH HAS A NOMINAL BREAKDOWN VOLTAGE OF 15.6V. PLEASE NOTE THAT THIS SUPPLY PIN SHOULD NOT BE DRIVEN BY A DC, LOW IMPEDANCE POWER SOURCE GREATER THAN THE VCLAMP SPECIFIED IN THE ELECTRICAL CHARACTERISTICS SECTION.

TABLE 3 TABLE 3B TABLE 3A

ELECTRICAL CHARACTERISTICS $V_{CC} = V_{BS} = V_{BIAS} = 14V +/-0.25$, $C_{LO} = C_{HO} = 1000 \text{ pF}$, $T_A = 25C \text{ UNLESS OTHERWISE SPECIFIED.}$

SYMBOL	SYMBOL DEFINITION	NIM	TYPE	MAX	UNITS	MAX UNITS TEST CONDITIONS	
SUPPLY CH	SUPPLY CHARACTERISTICS						
VCCUV+	V _{CC} SUPPLY UNDERVOLTAGE POSITIVE GOING THRESHOLD 10.5	10.5	11.5	12.5		V _{CC} RISING FROM 0V	Ć
	V _{CC} SUPPLY UNDERVOLTAGE NEGATIVE GOING THRESHOLD	8.5	9.5	10.5	>	V _{CC} FALLING FROM 14V	9/1
VUVHYS	V _{CC} SUPPLY UNDERVOLTAGE LOCKOUT HYSTERESIS	1.5	2.0	3.0			0_
laccuv	UVLO MODE QUIESCENT CURRENT	50	120	200		Vcc=11V	
I QCCFLT	FAULT-MODE QUIESCENT CURRENT	ļ	180	ı	<u>{</u>		
၁၁၀၂	QUIESCENT V _{CC} SUPPLY CURRENT	i	1.8	1	~	VCC=14V	
lcc50k	V _{CC} SUPPLY CURRENT, f = 50kHz	i	1.8	1	<u> </u>	:	
	V _{CC} ZENER CLAMP VOLTAGE	14.5	15.6	16.5	>	Icc=10mA	•
FLOATING (FLOATING SUPPLY CHARACTERISTICS			3			
lobso	QUIESCENT VBS SUPPLY CURRENT	7	0	5	ΔΠ	VHO = VS	
lQBS1	QUIESCENT VBS SUPPLY CURRENT	!	28	ŀ	<u>{</u>	VHO = VB	
VBSMIN	MINIMUM REQUIRED V _{BS} VOLTAGE FOR PROPER HO FUNCTIONALITY	1	2.5	ļ	^		
= X	OFFSET SUPPLY LEAKAGE CURRENT	1	ł	20	μA	$V_B = V_S 600V$	

OSCILLATOR	OSCILLATOR I/O CHARACTERISTICS						
FVCO(MIN)	FVCO(MIN) MINIMUM OSCILLATOR FREQUENCY	i	30		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	VCO=0V, RFMIN=39K	
FVCO(MAX)	FVCO(MAX) MAXIMUM OSCILLATOR FREQUENCY	1	110		ZUN	VCO=5V, FRMIN=39K	T
۵	OSCILLATOR DUTY CYCLE	-	50	1	%		
Tolo	LO OUTPUT DEADTIME	-	1.2		Sil	RFMIN=39K	
Трно	HO OUTPUT DEADTIME		1.2		2	RFMIN=39K	
Іусорн	PREHEAT MODE & FREQUENCY SWEEP MODE VCO PIN DISCHARGE CURRENT	ı	1.0	l	Ā	CVO <vcc< td=""><td></td></vcc<>	
IVCOADPT	ADAPTIVE MODE VCO PIN DISCHARGE CURRENT		16.0	i	-		
WVCOFLT	FAULT MODE & UVLO MODE VCO PIN VOLTAGE	-	5		۸		
GATE DRIVE	GATE DRIVEROUTPUT CHARACTERISTICS						10
Vol	LOW LEVEL OUTPUT VOLTAGE (HO OR LO)	-	-	100	/\~		
VHL	HIGH LEVEL OUTPUT VOLTAGE (HO OR LO)	I		100) 		,
TRISE	TURN ON RISE TIME	-		150	V N		
TFALL	TURN OFF FALL TIME			100	CNI		
PROTECTIC	PROTECTION CHARACTERISTICS			:		ω	
Vcsтн	PEAK OVER CURRENT LATCH THRESHOLD VOLTAGE	:	5	-	^		Ι
MINIMUM FI	MINIMUM FREQUENCY SETTING CHARACTERISTICS						
VFMIN	FMIN PIN VOLTAGE DURING NORMAL OPERATION		5.1		Λ		
VFMINFLT	FMIN PIN VOLTAGE DURING FAULT MODE		0.0	•	Λ	VCS >VCSTH	
					i		İ

TABLE 3B